## Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A manufacturing method for a three-dimensional structural body, photonic crystal, comprising:

A. holding, by a first holding member, a first cross-sectional form member from amongst a plurality of cross-sectional form members above a first-substrate; substrate, a pattern member comprising the first holding member and the first cross-sectional form member;

B. first bonding/transferring and laminating the first cross-sectional form member onto a second substrate;

C. releasing the first cross-sectional form member from the first holding member after the first bonding/transferring and laminating;

D. holding, by a second holding member, a second cross-sectional form member from amongst the plurality of cross-sectional form members above the first substrate;

E. second bonding/transferring and laminating the second cross-sectional form member onto the first cross-sectional form member;

F. releasing the second cross-sectional form member from the second holding member after the second bonding/transferring and laminating;

repeating Repeating steps D, E and F, at least once, wherein, for each repetition, the "second holding member" becomes a new holding member and "second the "second cross-sectional form member" becomes a new cross-sectional form member from amongst the plurality of cross-sectional form members and the "first cross-sectional form member" becomes the second cross-sectional form member from a previous repetition, respectively, wherein

each cross-sectional form member corresponds to a slice pattern of the three-dimensional-structural body. photonic crystal,

each cross-sectional form member comprises a plurality of longitudinal members separated by gaps from each other, each of the plurality of longitudinal members having two tips, one tip being connected to a lateral member, and the other tip being connected to another lateral member.

- 2. (Previously Presented) The manufacturing method according to claim 1, wherein the first or second bonding/transferring and laminating is performed using surface-activated bonding.
- 3. (Previously Presented) The manufacturing method according to claim 1, wherein the first or second holding member comprises a coupling member connected to a cross-sectional form member, and a frame member, wherein the first substrate is connected to the coupling member through the frame member.
- 4. (Original) The manufacturing method according to claim 3, wherein the frame member includes a columnar part provided on the first substrate, and a frame part provided on the columnar part and connected to the coupling member.
- 5. (Previously Presented) The manufacturing method according to claim 4, further comprising:

laminating a sacrificial layer and a material layer on the first substrate;
forming the cross-sectional form members, the frame part and the coupling
member in the material layer; and

removing the sacrificial layer while a portion becoming the columnar part remains, and a gap occurs at least between the cross-sectional form members and the first substrate.

- 6. (Previously Presented) The manufacturing method according to claim 5, wherein the plurality of cross-sectional form members are formed by using a lithography method.
- 7. (Original) The manufacturing method according to claim 5, wherein the sacrificial layer is removed by using an under etching method.
- 8. (Previously Presented) The manufacturing method according to claim 3, wherein the coupling member is ruptured at a time of the first or second bonding/transferring and laminating.
- 9. (Currently Amended) The manufacturing method according to claim 1, further comprising a collective of one or more cross-sectional form members, wherein \_\_\_\_\_\_the first or second bonding/transferring and laminating is performed by causing the collective of cross-sectional form members to face the second substrate, and by sandwiching the collective of cross-sectional form members between the first substrate and the second substrate., substrate, and \_\_\_\_\_\_\_the collective comprises a plurality of cross-sectional form members connected by a

lateral member so that the longitudinal members extend along a substantially same direction.

10. (Currently Amended) The manufacturing method according to claim 3, further comprising a collective of one or more cross-sectional form members, wherein \_\_\_\_\_\_the first or second bonding/transferring and laminating is performed by causing the collective of cross-sectional form members to face the second substrate, and by sandwiching the collective of cross-sectional form members between the first substrate and the second substrate, and substrate,

the coupling member is ruptured after the collective of cross-sectional form members are transferred on the second substrate and when the second substrate is separated from the first-substrate, substrate, and

by a lateral member so that the longitudinal members extend along a substantially same direction.

- 11. (Previously Presented) The manufacturing method according to claim 9, wherein a surface on the first substrate facing the collective of cross-sectional form members is flat.
- 12. (Previously Presented) The manufacturing method according to claim 10, wherein a surface on the first substrate facing the collective of cross-sectional form members is flat.
- 13. (Previously Presented) The manufacturing method according to claim 9, wherein a pressure to sandwich the collective of cross-sectional form members between the first substrate and the second substrate is applied to all of the cross-sectional form members of the collective.
- 14. (Previously Presented) The manufacturing method according to claim 10, wherein a pressure to sandwich the collective of cross-sectional form members between the first substrate and the second substrate is applied to all of the cross-sectional form members of the collective.
- 15. (Previously Presented) The manufacturing method according to claim 1, wherein the first or second holding member comprises a first frame member positioned on the first substrate, a second frame member provided inside of the first frame member, a first coupling member connected to a cross-sectional form member, and a second coupling member connecting the first and the second frame members.
- 16. (Previously Presented) The manufacturing method according to claim 15, wherein the second frame member and a plurality of cross-sectional form members connected

to the second frame member are simultaneously bonded and transferred onto the second substrate.

- 17. (Previously Presented) The manufacturing method according to claim 16, wherein the first and second bonding/transferring and laminating is performed by causing the second substrate and the plurality of cross-sectional form members connected to the second frame member to face each other, and by sandwiching the second frame member and the plurality of cross-sectional form members between the first substrate and the second substrate.
- 18. (Original) The manufacturing method according to claim 1, wherein the three-dimensional structural body includes a photonic crystal having a periodic structure.
- 19. (New) A manufacturing method for a three-dimensional structural body, comprising:

sequentially bonding/transferring and laminating a plurality of cross-sectional form members onto a second substrate, each cross-sectional form member being held in space above a first substrate by a holding member; and

releasing the cross-sectional form member from the holding member after the bonding/transferring and laminating, wherein

the bonding/transferring and laminating is performed using surface-activated bonding.

20. (New) A manufacturing method for a three-dimensional structural body, comprising:

sequentially bonding/transferring and laminating a plurality of cross-sectional form members onto a second substrate, each cross-sectional form member being held in space above a first substrate by a holding member; and

releasing the cross-sectional form member from the holding member after the bonding/transferring and laminating, wherein

the holding member comprises a coupling member connected to a crosssectional form member, and a frame member, wherein

the first substrate is connected to the coupling member through the frame member, wherein

the frame member includes a columnar part provided on the first substrate, and a frame part provided on the columnar part and connected to the coupling member;

the manufacturing method further comprising:

laminating a sacrificial layer and a material layer on the first substrate;

forming the cross-sectional form members, the frame part and the coupling member in the material layer; and

removing the sacrificial layer while a portion becoming the columnar part remains, and a gap occurs at least between the cross-sectional form members and the first substrate.